

## PRM012N03N3

# PFC Device Corporation

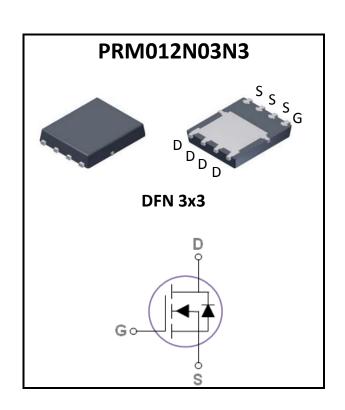
# 30V Single N-Channel MOSFET

### Major ratings and characteristics

Characteristics	Values	Units
V <sub>DS</sub>	30	٧
$I_{D}^{4} (T_{C}=25^{\circ}C)$	35	Α
Max. R <sub>DS(ON)</sub> @V <sub>GS</sub> =10V	12	mΩ
T <sub>J</sub> Operating Junction Temperature	-50 to +150	°C

## **General Description**

The N-Channel enhancement mode power field effect transistor is using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. The device is well suited for high efficiency fast switching applications.



## **Typical Applications**

- Charger Adapter
- Power Tools
- LED Lighting

#### **Features**

- Max.  $R_{DS(ON)}=12m\Omega @V_{GS}=10V$
- Improved dv/dt capability
- Fast switching
- 100% E<sub>AS</sub> Guaranteed
- Green Device Available

## 1. Characteristics

**Maximum Ratings Characteristics** 

( $T_A = 25$  °C unless otherwise specified)

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	30	V
$V_{GS}$	Gate-Source Voltage	±20	V
l <sub>D</sub> <sup>4</sup>	Drain Current – Continuous (T <sub>C</sub> =25°C)	35	А
ID	Drain Current – Continuous (T <sub>C</sub> =100°C)	22	Α
I <sub>DM</sub>	Drain Current – Pulsed <sup>1</sup>	140	Α
E <sub>AS</sub>	Single Pulse Avalanche Energy <sup>2</sup>	7.6	mJ
I <sub>AS</sub>	Single Pulse Avalanche Current <sup>2</sup>	12	Α
В	Power Dissipation (T <sub>C</sub> =25°C)	27	W
P <sub>D</sub>	Power Dissipation – Derate above 25°C	0.21	W/°C
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C
$T_J$	Operating Junction Temperature Range	-55 to 150	°C

#### **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient		62	°C/W
$R_{ heta JC}$	Thermal Resistance Junction to Case		4.6	°C/W



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#### **Electrical Characteristics**

( $T_J = 25$  °C unless otherwise specified)

#### Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	30			V
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C			1	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V			100	nA

#### **On Characteristics**

В	Static Drain-Source On-Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =10A		9,4	12	mΩ
R <sub>DS(ON)</sub>		$V_{GS}$ =4.5V, $I_D$ =5A		13	18	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_{D}=250uA$	1.0	1.8	2.5	V
g <sub>fs</sub>	Forward Transconductance	V <sub>DS</sub> =5V, I <sub>D</sub> =10A		28		S

**Dynamic and switching Characteristics** 

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$Q_{g}$	Total Gate Charge	V <sub>DS</sub> =15V, V <sub>GS</sub> =4.5V, I <sub>D</sub> =20A		7.7	
$Q_gs$	Gate-Source Charge			2.6	 nC
$Q_gd$	Gate-Drain Charge			3.4	
$T_{d(on)}$	Turn-On Delay Time			6.2	
T <sub>r</sub>	Turn-On Rise Time	$V_{DD}$ =15V, $V_{GS}$ =10V, $R_{G}$ =3.3 $\Omega$ $I_{D}$ =15A		21	 ne
$T_{d(off)}$	Turn-Off Delay Time			24	 ns
$T_f$	Turn-Off Fall Time		-	15	
$C_{iss}$	Input Capacitance		-	721	
C <sub>oss</sub>	Output Capacitance	$V_{DS}$ =25V, $V_{GS}$ =0V, f=1MHz	-	96	 pF
C <sub>rss</sub>	Reverse Transfer Capacitance			65	
$R_{g}$	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz		2.7	 Ω

#### **Drain-Source Diode Characteristics**

#### Note:

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2.  $V_{DD}$ =25V,  $V_{GS}$ =10V, L=0.1mH,  $I_{AS}$ =12A, RG=25 $\Omega$ , Starting TJ=25 $^{\circ}$ C
- 3. The data tested by pulsed, pulse width  $\leq$ 300us, duty cycle  $\leq$ 2%.
- 4. Silicon limited.

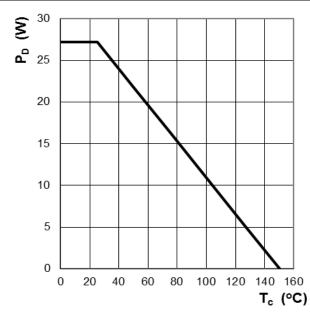


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## 2. Characteristics Curves

### **Ratings and Characteristics Curves**

### (T<sub>A</sub> = 25°C unless otherwise specified)



**Figure 1: Power Dissipation** 

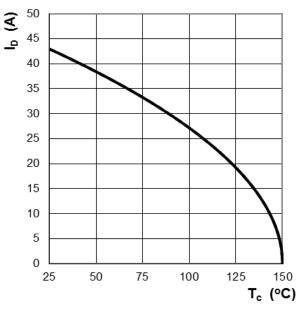


Figure 2: Continuous Drain Current vs. T<sub>C</sub>

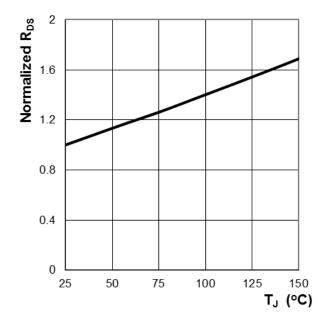


Figure 3: Normalized R<sub>DS(ON)</sub> vs. T<sub>J</sub>

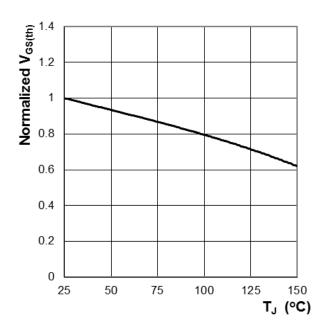


Figure 4: Normalized  $V_{GS(th)}$  vs.  $T_J$ 



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**Ratings and Characteristics Curves** 

( $T_A = 25^{\circ}$ C unless otherwise specified)

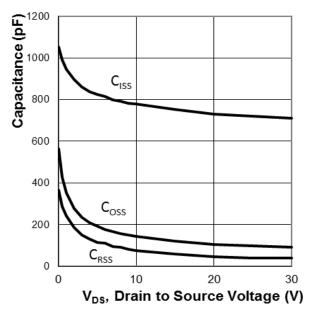


Figure 5: Typ. Capacitance Characteristics

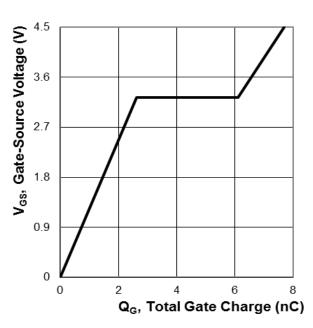


Figure 6: Typ. Gate Charge Characteristics

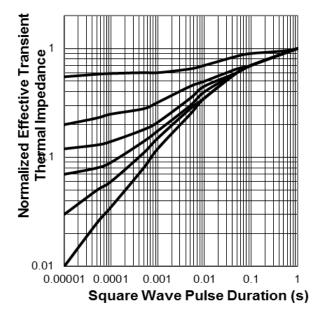
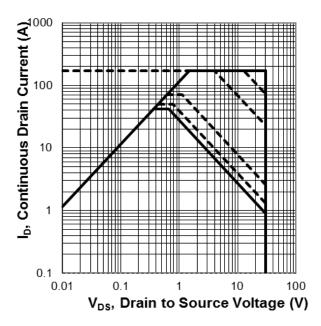


Figure 7: Normalized Thermal Transient Impedance, Junction-to-Case



**Figure 8: Maximum Safe Operation Area** 



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## 3. Marking information

**Top Marking Rule** 

PFC PRM 012N03 YM ABS PRM012N03 = Product Type Marking Code

YM = Date Code

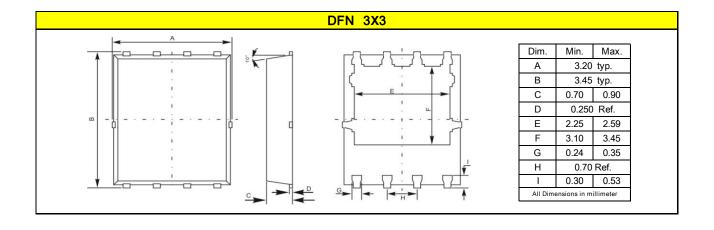
Y = Year code

M = Month code

ABS = Assembly code

## 4. Package information

Package Outline Dimensions millimeters





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## 5. Ordering information

Part Number	Package	Delivery mode
PRM012N03N3	DFN 3X3	5000 pcs / 13" diameter reel

#### Mechanical

Molder Plastic: UL Flammability Classification Rating 94V-0
Device Weight: 0.0025 ounces (0.072grams) – DFN 3X3

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